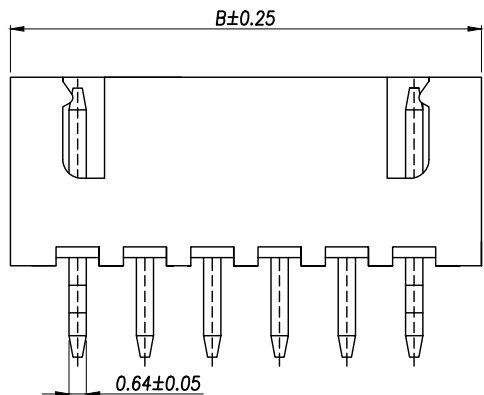
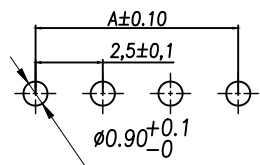


技术要求:

1. 零件材料: PA66(UL-94V-0)
2. 接触件: 黄铜镀锡
3. 接触电阻: $\leq 10m\Omega$
4. 绝缘电阻: $\geq 100M\Omega$
5. 额定电压: 250V AC DC
6. 额定电流: 2.0A AC DC
7. 耐压: 能承受 1000V AC/Minute
8. 工作温度: $-25^{\circ}\sim+85^{\circ}$
9. 可焊性试验: 浸锡面积 $>95\%$ 温度 235° , 时间 2.5 ± 0.5 秒
10. 铅和镉等六大有害物质含量要符合环保要求。



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

Part No	Pin	A	B
XY-HX25003-2A	2	2.50	7.50
XY-HX25003-3A	3	5.00	10.00
XY-HX25003-4A	4	7.50	12.50
XY-HX25003-5A	5	10.00	15.00
XY-HX25003-6A	6	12.50	17.50
XY-HX25003-7A	7	15.00	20.00
XY-HX25003-8A	8	17.50	22.50
XY-HX25003-9A	9	20.00	25.00
XY-HX25003-10A	10	22.50	27.50
XY-HX25003-11A	11	25.00	30.00
XY-HX25003-12A	12	27.50	32.50
XY-HX25003-13A	13	30.00	35.00
XY-HX25003-14A	14	32.50	37.50
XY-HX25003-15A	15	35.00	40.00
XY-HX25003-16A	16	37.50	42.50
XY-HX25003-17A	17	40.00	45.00
XY-HX25003-18A	18	42.50	47.50
XY-HX25003-19A	19	45.00	50.00
XY-HX25003-20A	20	47.50	52.50

2	端子Contact	黄铜	N*1	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u"MIN
1	基座Wafer	PA66(UL94V-0)	1	白色
序号	名称	材料	数量	备注

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.35	X.*±5°	APR.	Alex	TITLE: WAFER XH2.54MM 直针	
.XX±0.25	.X.*±3°	CHK.	Jack	DWG NO. XY-HX25003-NA	
.XXX±0.15	.XX.*±1°	DRA.	Can	PROJ.	CUSTOMER DRAWING
SIZE A4	SCALE 1:1	SHEET 1/1	REV. A		